

# MJD243, NJVMJD243T4G (NPN), MJD253, NJVMJD253T4G (PNP)

## Complementary Silicon Plastic Power Transistor

### DPAK-3 for Surface Mount Applications

Designed for low voltage, low-power, high-gain audio amplifier applications.

#### Features

- Collector-Emitter Sustaining Voltage –  
 $V_{CE(sus)} = 100 \text{ Vdc (Min) @ } I_C$   
 $= 10 \text{ mAdc}$
- High DC Current Gain –  
 $h_{FE} = 40 \text{ (Min) @ } I_C$   
 $= 200 \text{ mAdc}$   
 $= 15 \text{ (Min) @ } I_C = 1.0 \text{ Adc}$
- Lead Formed for Surface Mount Applications in Plastic Sleeves (No Suffix)
- Straight Lead Version in Plastic Sleeves (“-1” Suffix)
- Low Collector-Emitter Saturation Voltage –  
 $V_{CE(sat)} = 0.3 \text{ Vdc (Max) @ } I_C$   
 $= 500 \text{ mAdc}$   
 $= 0.6 \text{ Vdc (Max) @ } I_C = 1.0 \text{ Adc}$
- High Current-Gain – Bandwidth Product –  
 $f_T = 40 \text{ MHz (Min) @ } I_C$   
 $= 100 \text{ mAdc}$
- Annular Construction for Low Leakage –  
 $I_{CBO} = 100 \text{ nAdc @ Rated } V_{CB}$
- Epoxy Meets UL 94 V-0 @ 0.125 in
- ESD Ratings:
  - Human Body Model,  $3B > 8000 \text{ V}$
  - Machine Model,  $C > 400 \text{ V}$
- NJV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free Packages\*



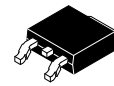
**ON Semiconductor®**

<http://onsemi.com>

**4.0 A, 100 V, 12.5 W  
POWER TRANSISTOR**

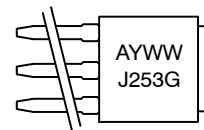


**IPAK  
CASE 369D  
STYLE 1**

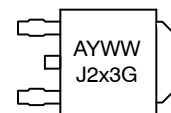


**DPAK-3  
CASE 369C  
STYLE 1**

#### MARKING DIAGRAMS



**IPAK**



**DPAK**

A = Assembly Location  
 Y = Year  
 WW = Work Week  
 x = 4 or 5  
 G = Pb-Free Package

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MJD243, NJVMJD243T4G (NPN), MJD253, NJVMJD253T4G (PNP)

## MAXIMUM RATINGS

| Rating                                                                                             | Symbol         | Value        | Unit                     |
|----------------------------------------------------------------------------------------------------|----------------|--------------|--------------------------|
| Collector–Base Voltage                                                                             | $V_{CB}$       | 100          | Vdc                      |
| Collector–Emitter Voltage                                                                          | $V_{CEO}$      | 100          | Vdc                      |
| Emitter–Base Voltage                                                                               | $V_{EB}$       | 7.0          | Vdc                      |
| Collector Current<br>Continuous<br>Peak                                                            | $I_C$          | 4.0<br>8.0   | Adc                      |
| Base Current                                                                                       | $I_B$          | 1.0          | Adc                      |
| Total Device Dissipation<br>@ $T_C = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$          | $P_D$          | 12.5<br>0.1  | W<br>W/ $^\circ\text{C}$ |
| Total Device Dissipation<br>@ $T_A = 25^\circ\text{C}$ (Note 2)<br>Derate above $25^\circ\text{C}$ | $P_D$          | 1.4<br>0.011 | W<br>W/ $^\circ\text{C}$ |
| Operating and Storage Junction Temperature Range                                                   | $T_J, T_{stg}$ | –65 to +150  | $^\circ\text{C}$         |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. When surface mounted on minimum pad sizes recommended.

## THERMAL CHARACTERISTICS

| Characteristic                                                         | Symbol                             | Value      | Unit                      |
|------------------------------------------------------------------------|------------------------------------|------------|---------------------------|
| Thermal Resistance<br>Junction–to–Case<br>Junction–to–Ambient (Note 2) | $R_{\theta JC}$<br>$R_{\theta JA}$ | 10<br>89.3 | $^\circ\text{C}/\text{W}$ |

2. When surface mounted on minimum pad sizes recommended.

## ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|----------------|--------|-----|-----|------|
|----------------|--------|-----|-----|------|

### OFF CHARACTERISTICS

|                                                                                                                                                               |                |          |            |                         |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|----------|------------|-------------------------|
| Collector–Emitter Sustaining Voltage (Note 3)<br>( $I_C = 10\text{ mAdc}$ , $I_B = 0$ )                                                                       | $V_{CEO(sus)}$ | 100      | –          | Vdc                     |
| Collector Cutoff Current<br>( $V_{CB} = 100\text{ Vdc}$ , $I_E = 0$ )<br>( $V_{CB} = 100\text{ Vdc}$ , $I_E = 0$ , $T_J = 125^\circ\text{C}$ )                | $I_{CBO}$      | –<br>–   | 100<br>100 | nAdc<br>$\mu\text{Adc}$ |
| Emitter Cutoff Current<br>( $V_{BE} = 7.0\text{ Vdc}$ , $I_C = 0$ )                                                                                           | $I_{EBO}$      | –        | 100        | nAdc                    |
| DC Current Gain (Note 3)<br>( $I_C = 200\text{ mAdc}$ , $V_{CE} = 1.0\text{ Vdc}$ )<br>( $I_C = 1.0\text{ Adc}$ , $V_{CE} = 1.0\text{ Vdc}$ )                 | $h_{FE}$       | 40<br>15 | 180<br>–   | –                       |
| Collector–Emitter Saturation Voltage (Note 3)<br>( $I_C = 500\text{ mAdc}$ , $I_B = 50\text{ mAdc}$ )<br>( $I_C = 1.0\text{ Adc}$ , $I_B = 100\text{ mAdc}$ ) | $V_{CE(sat)}$  | –<br>–   | 0.3<br>0.6 | Vdc                     |
| Base–Emitter Saturation Voltage (Note 3)<br>( $I_C = 2.0\text{ Adc}$ , $I_B = 200\text{ mAdc}$ )                                                              | $V_{BE(sat)}$  | –        | 1.8        | Vdc                     |
| Base–Emitter On Voltage (Note 3)<br>( $I_C = 500\text{ mAdc}$ , $V_{CE} = 1.0\text{ Vdc}$ )                                                                   | $V_{BE(on)}$   | –        | 1.5        | Vdc                     |

### DYNAMIC CHARACTERISTICS

|                                                                                                                                  |          |    |    |     |
|----------------------------------------------------------------------------------------------------------------------------------|----------|----|----|-----|
| Current–Gain – Bandwidth Product (Note 4)<br>( $I_C = 100\text{ mAdc}$ , $V_{CE} = 10\text{ Vdc}$ , $f_{test} = 10\text{ MHz}$ ) | $f_T$    | 40 | –  | MHz |
| Output Capacitance<br>( $V_{CB} = 10\text{ Vdc}$ , $I_E = 0$ , $f = 0.1\text{ MHz}$ )                                            | $C_{ob}$ | –  | 50 | pF  |

3. Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\approx 2\%$ .

4.  $f_T = |h_{FE}| \cdot f_{test}$ .

# MJD243, NJVMJD243T4G (NPN), MJD253, NJVMJD253T4G (PNP)

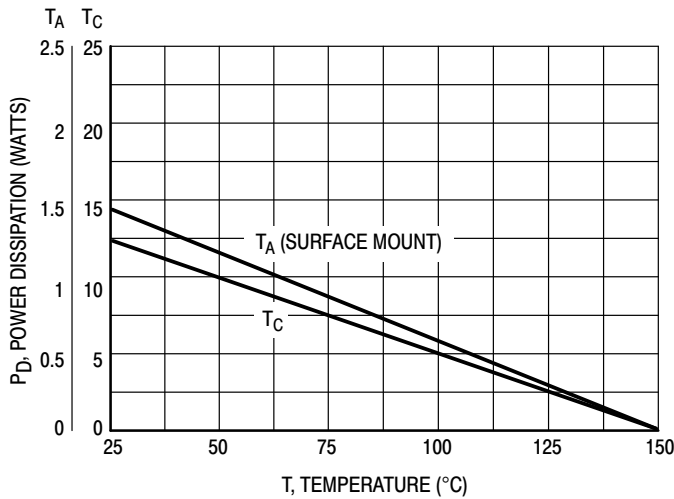


Figure 1. Power Derating

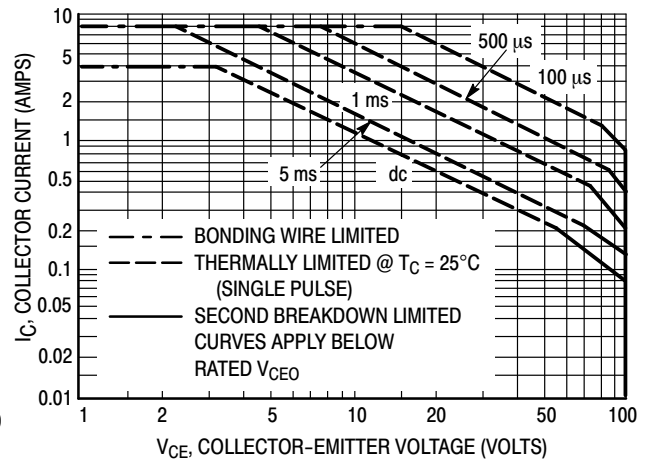


Figure 2. Active Region Maximum Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on  $T_{J(pk)} = 150^\circ\text{C}$ ;  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} \leq 150^\circ\text{C}$ .  $T_{J(pk)}$  may be calculated from the data in Figure 3. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

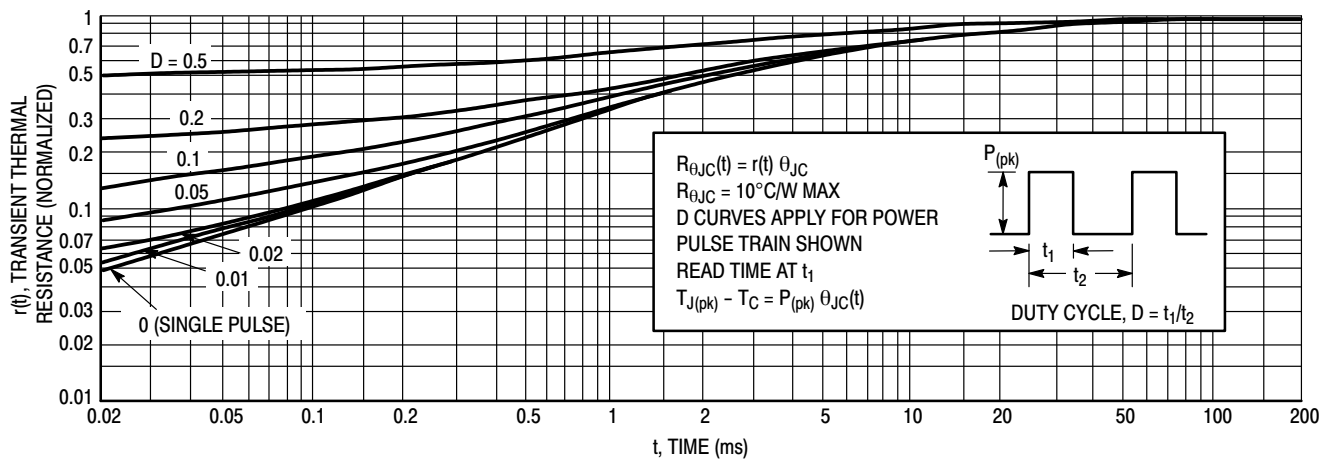
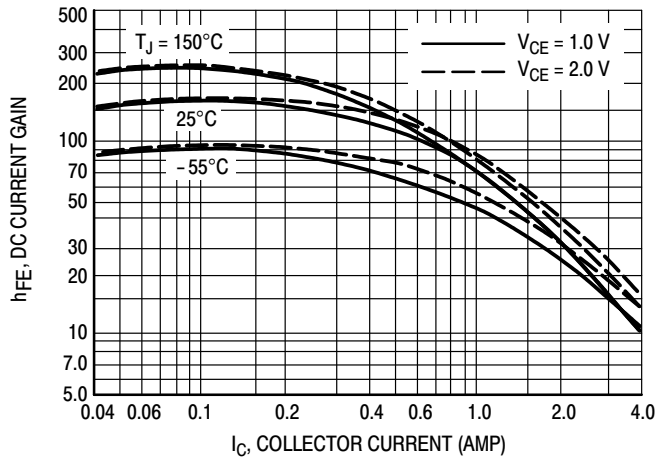


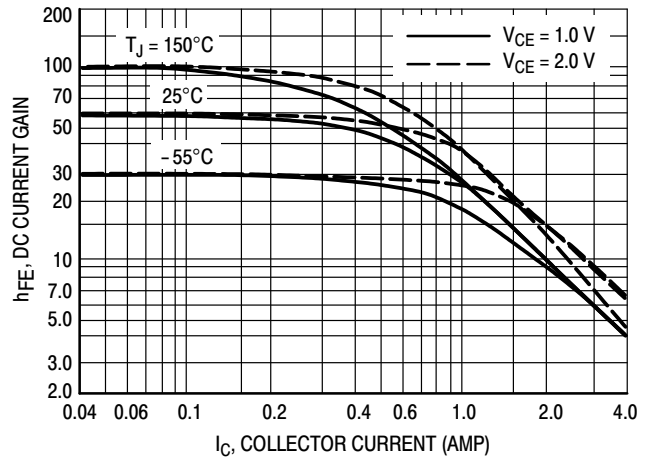
Figure 3. Thermal Response

# MJD243, NJVMJD243T4G (NPN), MJD253, NJVMJD253T4G (PNP)

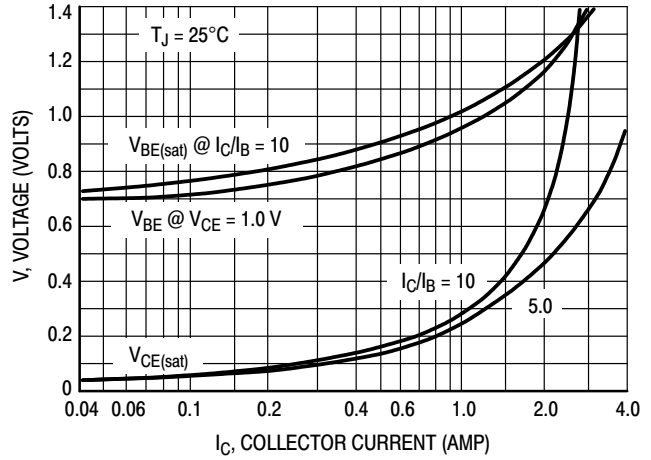
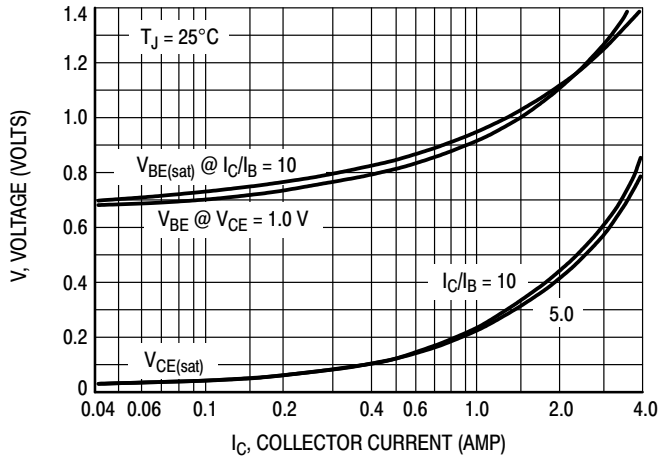
**NPN  
MJD243**



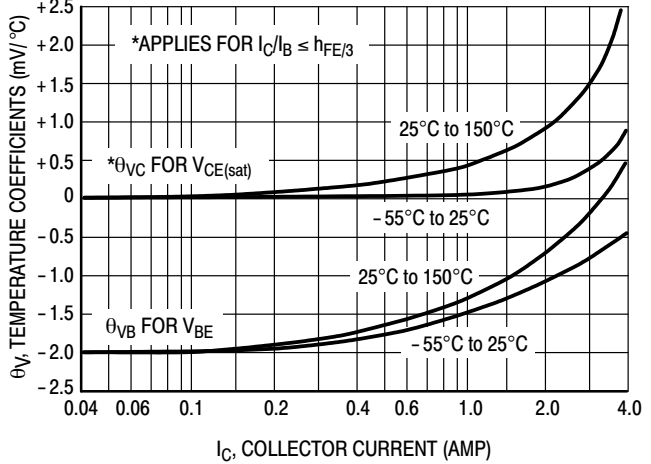
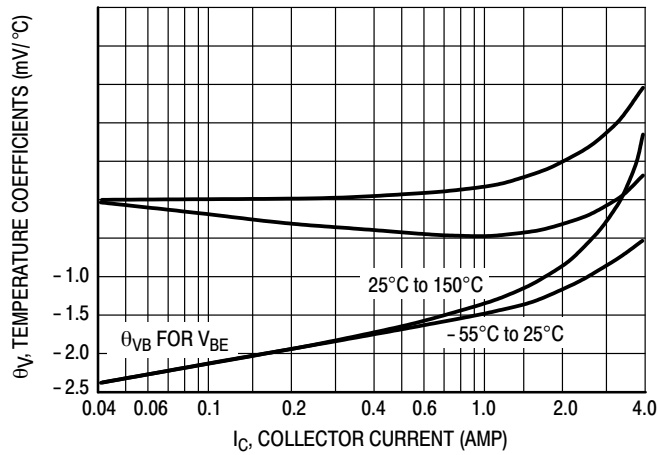
**PNP  
MJD253**



**Figure 4. DC Current Gain**



**Figure 5. "On" Voltages**



**Figure 6. Temperature Coefficients**

# MJD243, NJVMJD243T4G (NPN), MJD253, NJVMJD253T4G (PNP)

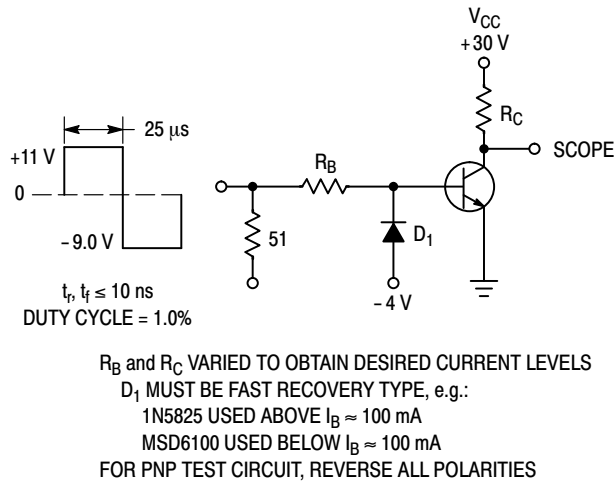


Figure 7. Switching Time Test Circuit

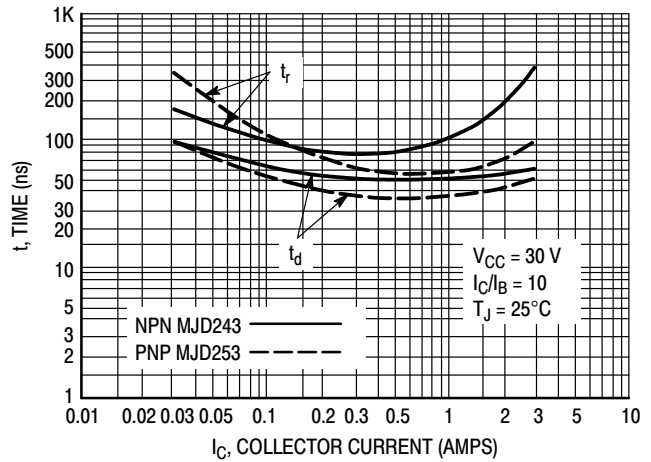


Figure 8. Turn-On Time

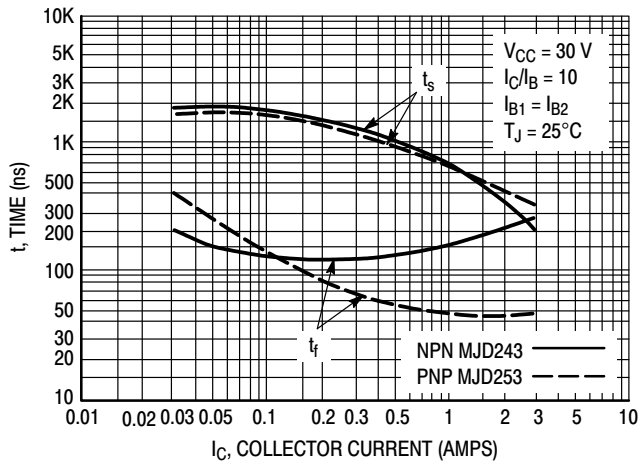


Figure 9. Turn-Off Time

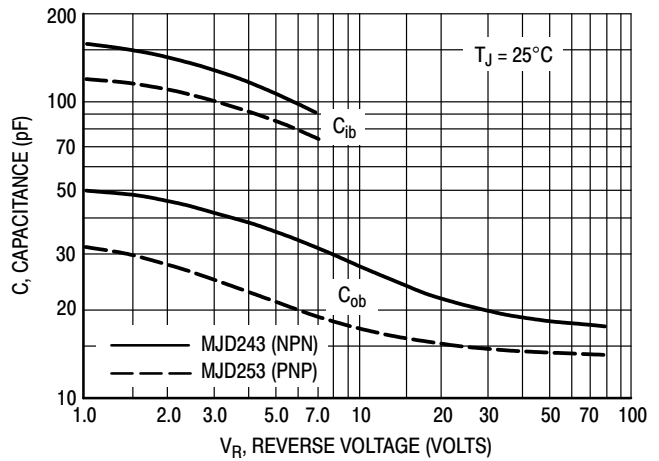


Figure 10. Capacitance

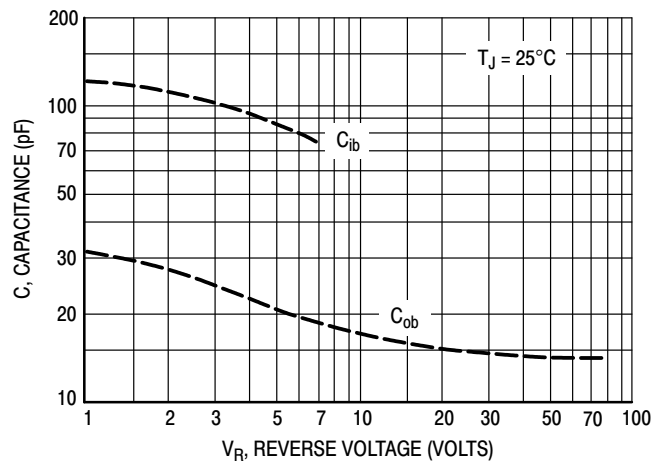


Figure 11. Capacitance

## MJD243, NJVMJD243T4G (NPN), MJD253, NJVMJD253T4G (PNP)

### ORDERING INFORMATION

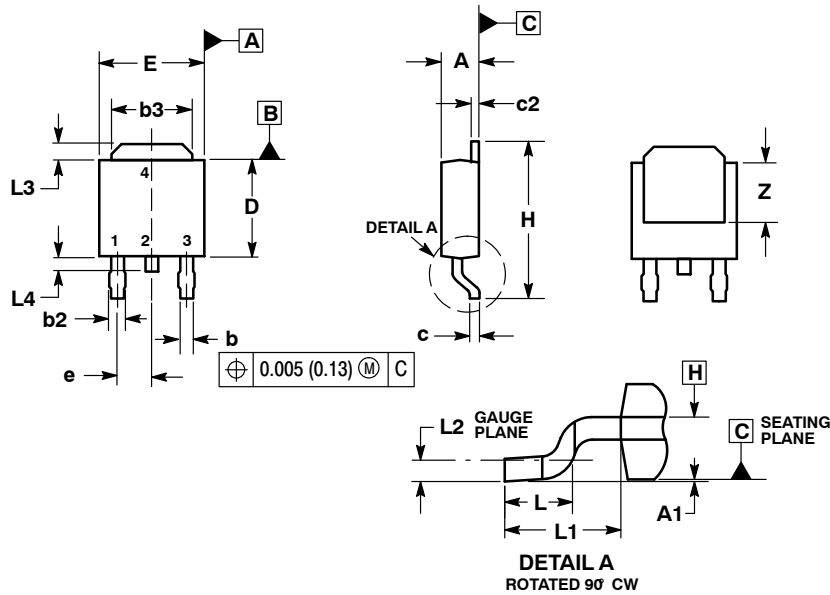
| Device       | Package Type        | Package | Shipping <sup>†</sup> |
|--------------|---------------------|---------|-----------------------|
| MJD243G      | DPAK-3<br>(Pb-Free) | 369C    | 75 Units / Rail       |
| MJD243T4G    | DPAK-3<br>(Pb-Free) | 369C    | 2,500 / Tape & Reel   |
| NJVMJD243T4G | DPAK-3<br>(Pb-Free) | 369C    | 2,500 / Tape & Reel   |
| MJD253-1G    | IPAK<br>(Pb-Free)   | 369D    | 75 Units / Rail       |
| MJD253T4G    | DPAK-3<br>(Pb-Free) | 369C    | 2,500 / Tape & Reel   |
| NJVMJD253T4G | DPAK-3<br>(Pb-Free) | 369C    | 2,500 / Tape & Reel   |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MJD243, NJVMJD243T4G (NPN), MJD253, NJVMJD253T4G (PNP)

## PACKAGE DIMENSIONS

### DPAK-3 CASE 369C-01 ISSUE D

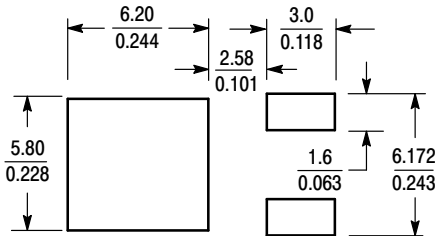


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3 and Z.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.

| DIM | INCHES |       | MILLIMETERS |       |
|-----|--------|-------|-------------|-------|
|     | MIN    | MAX   | MIN         | MAX   |
| A   | 0.086  | 0.094 | 2.18        | 2.38  |
| A1  | 0.000  | 0.005 | 0.00        | 0.13  |
| b   | 0.025  | 0.035 | 0.63        | 0.89  |
| b2  | 0.030  | 0.045 | 0.76        | 1.14  |
| b3  | 0.180  | 0.215 | 4.57        | 5.46  |
| c   | 0.018  | 0.024 | 0.46        | 0.61  |
| c2  | 0.018  | 0.024 | 0.46        | 0.61  |
| D   | 0.235  | 0.245 | 5.97        | 6.22  |
| E   | 0.250  | 0.265 | 6.35        | 6.73  |
| e   | 0.090  | BSC   | 2.29        | BSC   |
| H   | 0.370  | 0.410 | 9.40        | 10.41 |
| L   | 0.055  | 0.070 | 1.40        | 1.78  |
| L1  | 0.108  | REF   | 2.74        | REF   |
| L2  | 0.020  | BSC   | 0.51        | BSC   |
| L3  | 0.035  | 0.050 | 0.89        | 1.27  |
| L4  | ---    | 0.040 | ---         | 1.01  |
| Z   | 0.155  | ---   | 3.93        | ---   |

#### SOLDERING FOOTPRINT\*



SCALE 3:1 (mm / inches)

#### STYLE 1:

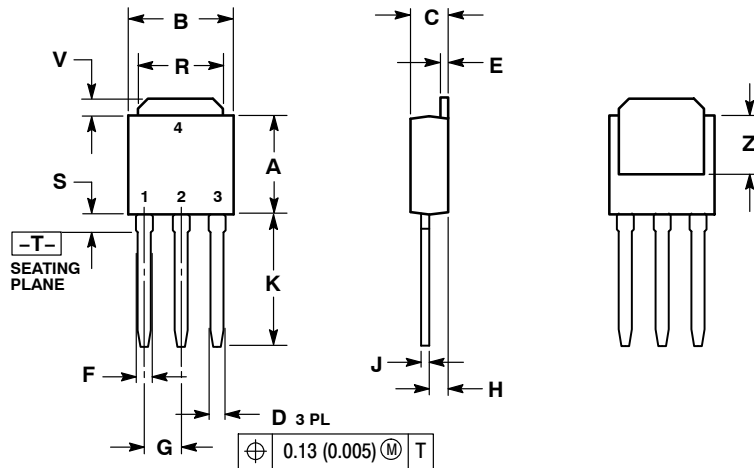
- PIN 1. BASE
- COLLECTOR
- EMITTER
- COLLECTOR

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MJD243, NJVMJD243T4G (NPN), MJD253, NJVMJD253T4G (PNP)

## PACKAGE DIMENSIONS

### IPAK CASE 369D-01 ISSUE C



#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES |       | MILLIMETERS |      |
|-----|--------|-------|-------------|------|
|     | MIN    | MAX   | MIN         | MAX  |
| A   | 0.235  | 0.245 | 5.97        | 6.35 |
| B   | 0.250  | 0.265 | 6.35        | 6.73 |
| C   | 0.086  | 0.094 | 2.19        | 2.38 |
| D   | 0.027  | 0.035 | 0.69        | 0.88 |
| E   | 0.018  | 0.023 | 0.46        | 0.58 |
| F   | 0.037  | 0.045 | 0.94        | 1.14 |
| G   | 0.090  | BSC   | 2.29        | BSC  |
| H   | 0.034  | 0.040 | 0.87        | 1.01 |
| J   | 0.018  | 0.023 | 0.46        | 0.58 |
| K   | 0.350  | 0.380 | 8.89        | 9.65 |
| R   | 0.180  | 0.215 | 4.45        | 5.45 |
| S   | 0.025  | 0.040 | 0.63        | 1.01 |
| V   | 0.035  | 0.050 | 0.89        | 1.27 |
| Z   | 0.155  | ---   | 3.93        | ---  |

#### STYLE 1:

- PIN 1: BASE
- 2: COLLECTOR
- 3: EMITTER
- 4: COLLECTOR

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- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
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- Поставка электронных компонентов под контролем ВП;
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- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
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## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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Электронная почта: [ocean@oceanchips.ru](mailto:ocean@oceanchips.ru)

Web: <http://oceanchips.ru/>

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